# 9-146280-0 - ACTIVE

#### AMPMODU | AMPMODU Headers

TE Internal #: 9-146280-0 PCB Mount Header, Vertical, Board-to-Board, 40 Position, 2.54 mm [.1 in] Centerline, Breakaway, Gold, Through Hole - Solder, Signal, AMPMODU Headers

#### View on TE.com >

#### Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: 40

Number of Rows: 1

#### Features



#### **Product Type Features**

PCB Connector Assembly Type	PCB Mount Header	
Connector System	Board-to-Board	
Header Type	Breakaway	
Sealable	No	
Connector & Contact Terminates To	Printed Circuit Board	
Configuration Features		
Connector Contact Load Condition	Fully Loaded	
PCB Mount Orientation	Vertical	
Number of Positions	40	
Number of Rows	1	
Board-to-Board Configuration	Parallel	
Body Features		
Primary Product Color	Black	
Contact Features		

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Mating Square Post Dimension	.64 mm[.025 in]	
	100 – 200 µin	
PCB Contact Termination Area Plating Material Finish	Matte	
Contact Shape & Form	Square	
Contact Underplating Material	Nickel	
PCB Contact Termination Area Plating Material	Tin-Lead	
Contact Base Material	Copper Alloy	
Contact Mating Area Plating Material	Gold	
Contact Mating Area Plating Material Thickness	.381 μm[15 μin]	
Contact Type	Pin	
Contact Current Rating (Max)	3 A	
Termination Features		
Square Termination Post & Tail Dimension	.64 mm[.025 in]	
Termination Post & Tail Length	3.05 mm[.12 in]	
Termination Method to Printed Circuit Board	Through Hole - Solder	
Mechanical Attachment		
PCB Mount Retention Type	Solder Tail	

Mating Alignment	Without	
PCB Mount Retention	Without	
PCB Mount Alignment	Without	
Connector Mounting Type	Board Mount	
Housing Features		
Centerline (Pitch)	2.54 mm[.1 in]	
Housing Material	LCP (Liquid Crystal Polymer), LCP-GF (Liquid Crystal Polymer)	
Dimensions		
PCB Thickness (Recommended)	1.6 mm[.063 in]	
Usage Conditions		
Housing Temperature Rating	High	
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]	
Operation/Application		
Circuit Application	Signal	

**C** For support call+1 800 522 6752

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#### **Industry Standards**

Approved Standards	CSA LR7189, UL E28476				
UL Flammability Rating	UL 94V-0				
Packaging Features					
Packaging Quantity	100				
Packaging Type	Carton				
Product Compliance For compliance documentation, visit the product page on TE.com>					
EU RoHS Directive 2011/65/EU	Compliant				
EU ELV Directive 2000/53/EC	Compliant				

China RoHS 2 Directive MIIT Order No 32, 2016

EU REACH Regulation (EC) No. 1907/2006

### No Restricted Materials Above Threshold Current ECHA Candidate List: JUNE 2023 (235)

Candidate List Declared Against: JAN 2023 (233)

Does not contain REACH SVHC

Low Bromine/Chlorine - Br and Cl < 900 ppm per homogenous material. Also BFR /CFR/PVC Free

#### Halogen Content

#### Pin-in-Paste capable to 260°C

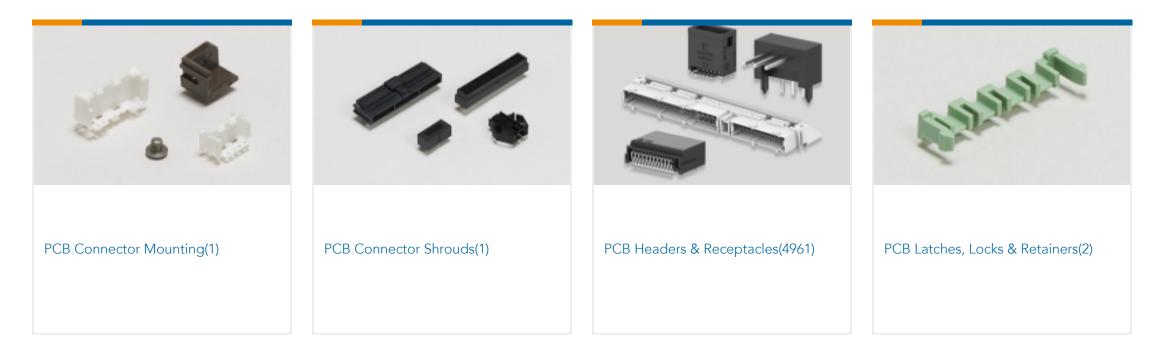
#### Product Compliance Disclaimer

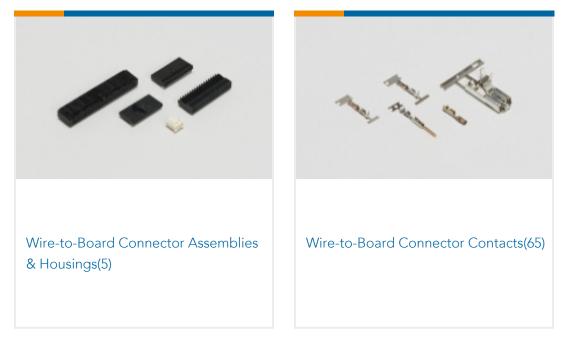
This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

### Also in the Series AMPMODU Headers

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## Customers Also Bought



CT CONN MT HDR ASSY H 7P NAT	DRD16E04=ROT DIP,16P	MOD IV RECP LP	KEYING PLUG,NOVO RCPT
	E TE	THIS THE	201
TE Part #3-2176230-0 3522 220R 5% 3W	TE Part #2-1879338-9 CPF 0603 52K3 1% 50PPM 1K RL	TE Part #1977104-4 STV08=8 POS SIP SWITCH	TE Part #5-2176325-7 CRGP 0402 470K 1%



### Documents

PCB Mount Header, Vertical, Board-to-Board, 40 Position, 2.54 mm [.1 in] Centerline, Breakaway, Gold, Through Hole - Solder, Signal, AMPMODU Headers



#### **CAD** Files

3D PDF

3D

Customer View Model

ENG\_CVM\_CVM\_9-146280-0\_D.2d\_dxf.zip

English

Customer View Model

ENG\_CVM\_CVM\_9-146280-0\_D.3d\_igs.zip

English

Customer View Model

ENG\_CVM\_CVM\_9-146280-0\_D.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the Terms and Conditions of use.

Datasheets & Catalog Pages AMPMODU\_INTERCONNECTION\_SYSTEM\_SECTION5

English

Product Environmental Compliance

Product Compliance Document

English

Product Compliance Document

English